

MOS FIELD EFFECT TRANSISTOR

2SJ355

P-CHANNEL MOS FET FOR HIGH SWITCHING

The 2SJ355 is a P-channel MOS FET of a vertical type and is a switching element that can be directly driven by the output of an IC operating at 5 V.

This product has a low ON resistance and superb switching characteristics and is ideal for driving the actuators and DC/DC converters.

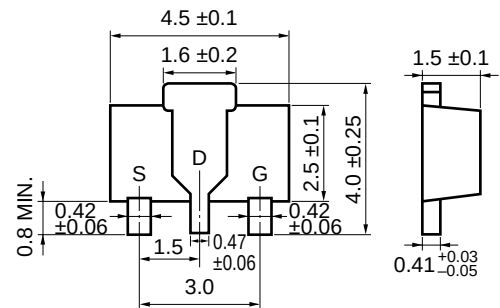
FEATURES

- Can be directly driven by 5-V IC
- Low ON resistance

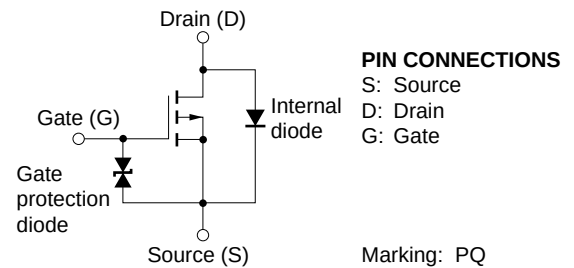
$R_{DS(on)} = 0.60 \, \Omega$ MAX. @ $V_{GS} = -4 \, V$, $I_D = -1.0 \, A$

$R_{DS(on)} = 0.35 \, \Omega$ MAX. @ $V_{GS} = -10 \, V$, $I_D = -1.0 \, A$

PACKAGE DIMENSIONS (in mm)



EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \, ^\circ C$)

PARAMETER	SYMBOL	TEST CONDITIONS	RATING	UNIT
Drain to Source Voltage	V_{DS}	$V_{GS} = 0$	-30	V
Gate to Source Voltage	V_{GS}	$V_{DS} = 0$	-20/+10	V
Drain Current (DC)	$I_{D(DC)}$		±2.0	A
Drain Current (Pulse)	$I_{D(pulse)}$	PW ≤ 10 ms Duty cycle ≤ 1 %	±4.0	A
Total Power Dissipation	P_T	16 cm ² × 0.7 mm, ceramic substrate used	2.0	W
Channel Temperature	T_{ch}		150	°C
Storage Temperature	T_{stg}		-55 to +150	°C

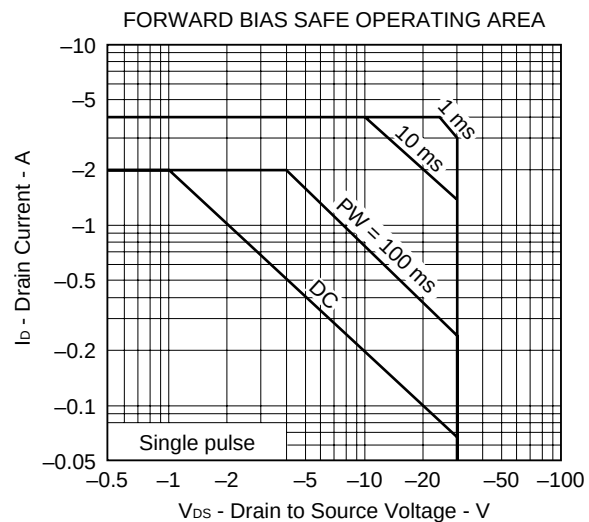
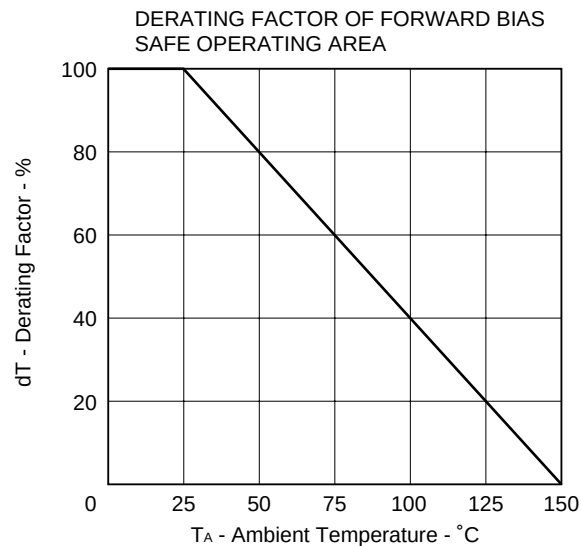
The internal diode connected between the gate and source of this product is to protect the product from static electricity. If the product is used in a circuit where the rated voltage of the product may be exceeded, connect a protection circuit.

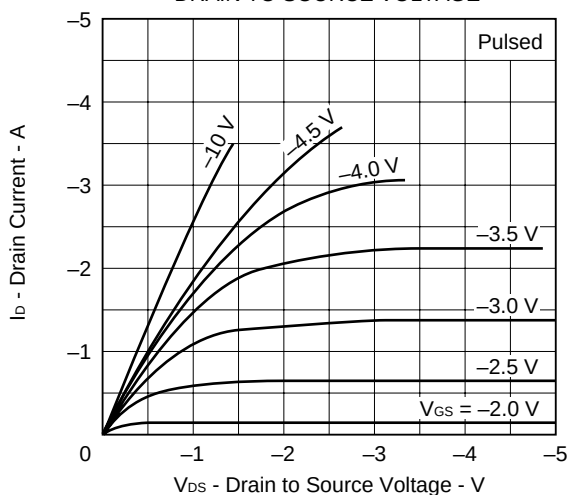
Take adequate preventive measures against static electricity when handling this product.

The information in this document is subject to change without notice.

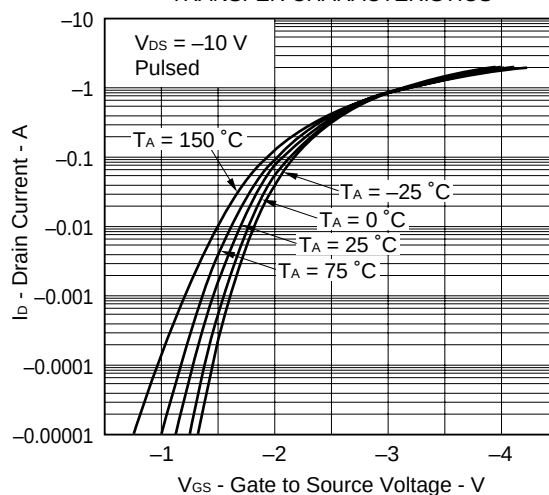
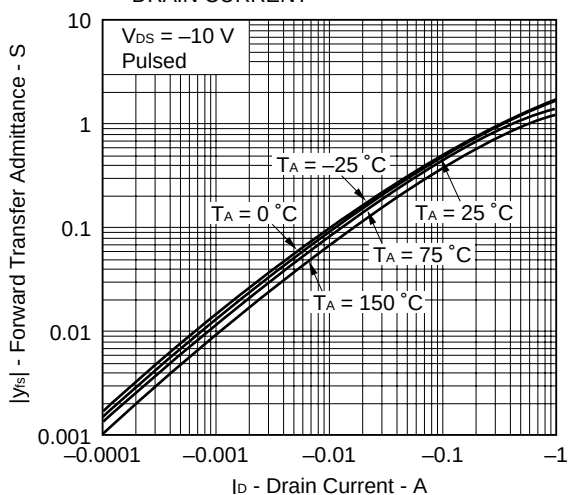
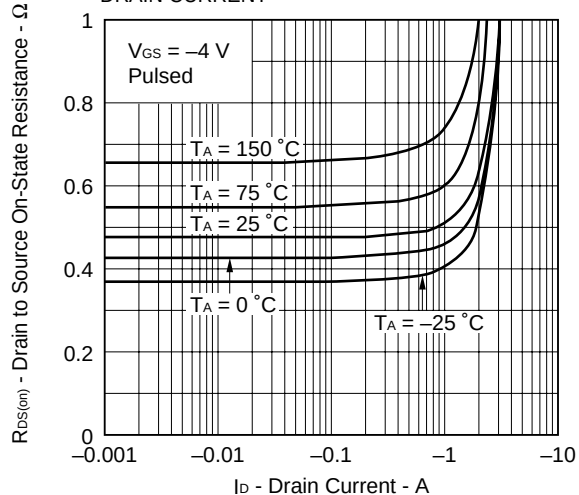
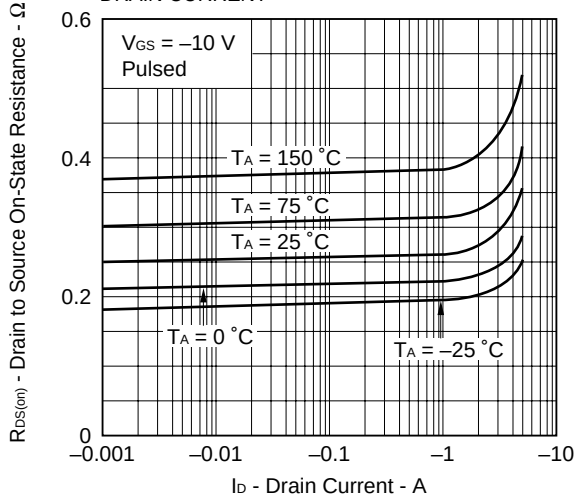
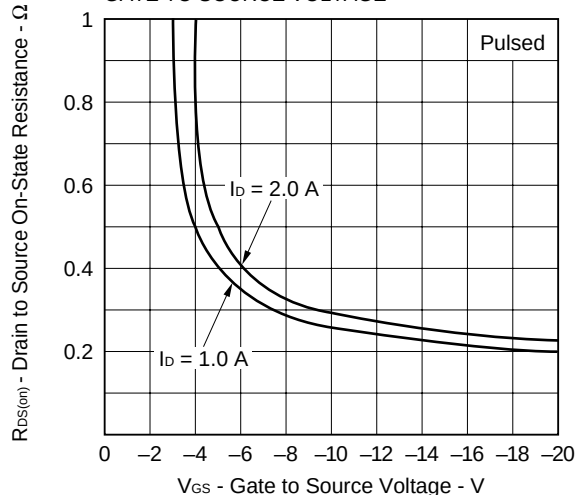
ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$)

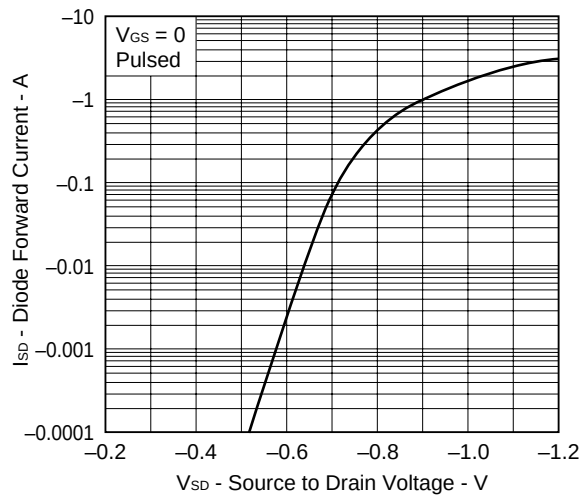
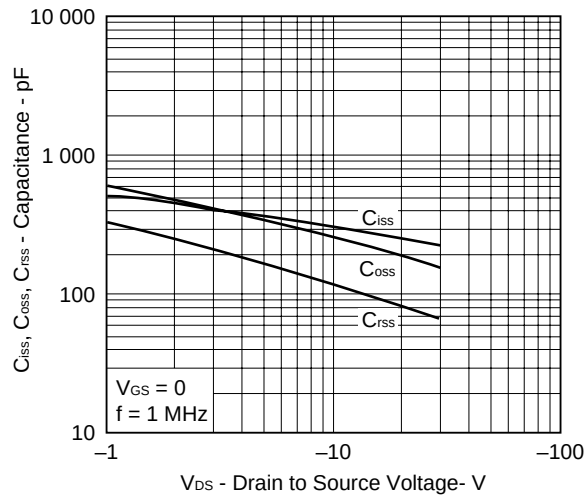
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-Off Current	I_{DSS}	$V_{DS} = -30\text{ V}$, $V_{GS} = 0$			-10	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = -16/+10\text{ V}$, $V_{DS} = 0$			± 10	μA
Gate Cut-Off Voltage	$V_{GS(off)}$	$V_{DS} = -10\text{ V}$, $I_D = -1\text{ mA}$	-1.0	-1.5	-2.0	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS} = -10\text{ V}$, $I_D = -1.0\text{ A}$	1.0			S
Drain to Source On-State Resistance	$R_{DS(on)1}$	$V_{GS} = -4\text{ V}$, $I_D = -1.0\text{ A}$		0.50	0.60	Ω
Drain to Source On-State Resistance	$R_{DS(on)2}$	$V_{GS} = -10\text{ V}$, $I_D = -1.0\text{ A}$		0.26	0.35	Ω
Input Capacitance	C_{iss}	$V_{DS} = -10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ MHz}$		300		pF
Output Capacitance	C_{oss}			245		pF
Reverse Transfer Capacitance	C_{rss}			120		pF
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -25\text{ V}$, $I_D = -1.0\text{ A}$ $V_{GS(on)} = -10\text{ V}$ $R_G = 10\text{ }\Omega$, $R_L = 25\text{ }\Omega$		5.5		ns
Rise Time	t_r			32		ns
Turn-Off Delay Time	$t_{d(off)}$			110		ns
Fall Time	t_f			130		ns
Gate Input Charge	Q_G	$V_{DS} = -24\text{ V}$, $V_{GS} = -10\text{ V}$, $I_D = -1.8\text{ A}$, $I_G = -2\text{ mA}$		12.2		nC
Gate to Source Charge	Q_{GS}			1.2		nC
Gate to Drain Charge	Q_{GD}			4.6		nC
Internal Diode Reverse Recovery Time	t_{rr}	$I_F = 2.0\text{ A}$, $di/dt = 50\text{ A}/\mu\text{s}$		95		ns
Internal Diode Reverse Recovery Charge	Q_{rr}			85		nC

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$)

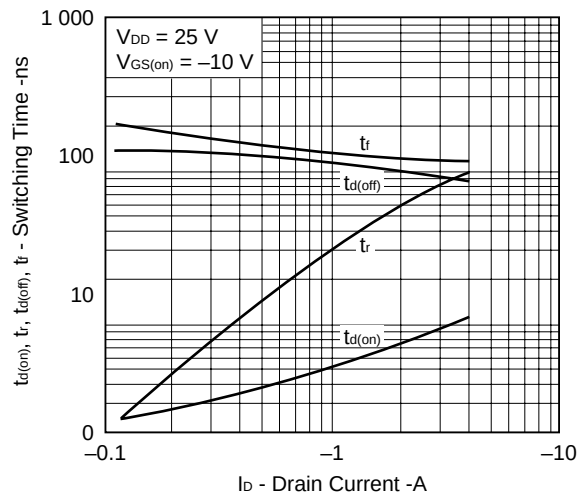
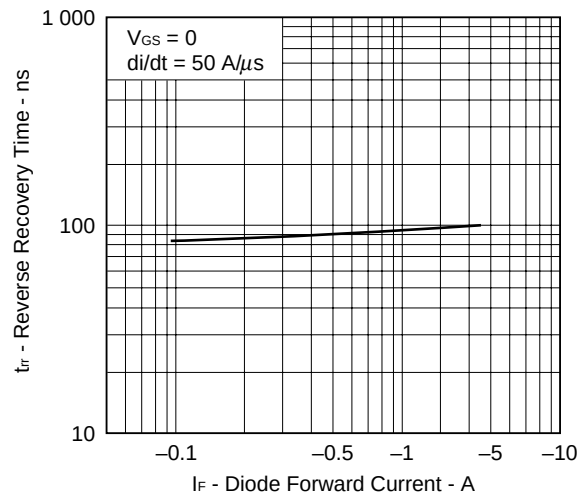
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE

TRANSFER CHARACTERISTICS

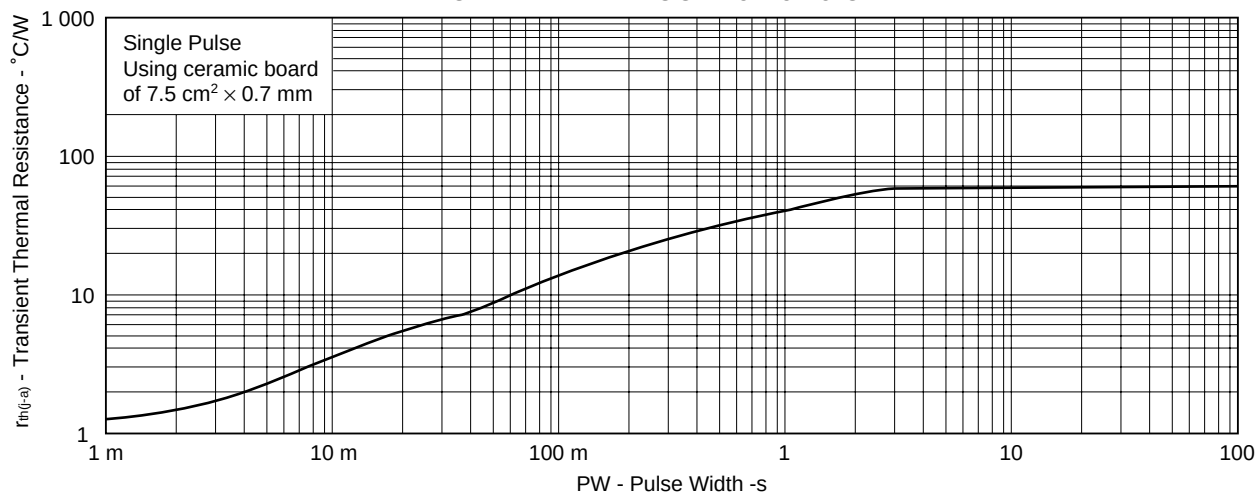
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENTDRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENTDRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENTDRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE

SOURCE TO DRAIN DIODE
FORWARD VOLTAGECAPACITANCE vs.
DRAIN TO SOURCE VOLTAGE

SWITCHING CHARACTERISTICS

REVERSE RECOVERY TIME vs.
DIODE FORWARD CURRENT

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	C10535E
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	X10679E

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices in “Standard” unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.

Anti-radioactive design is not implemented in this product.